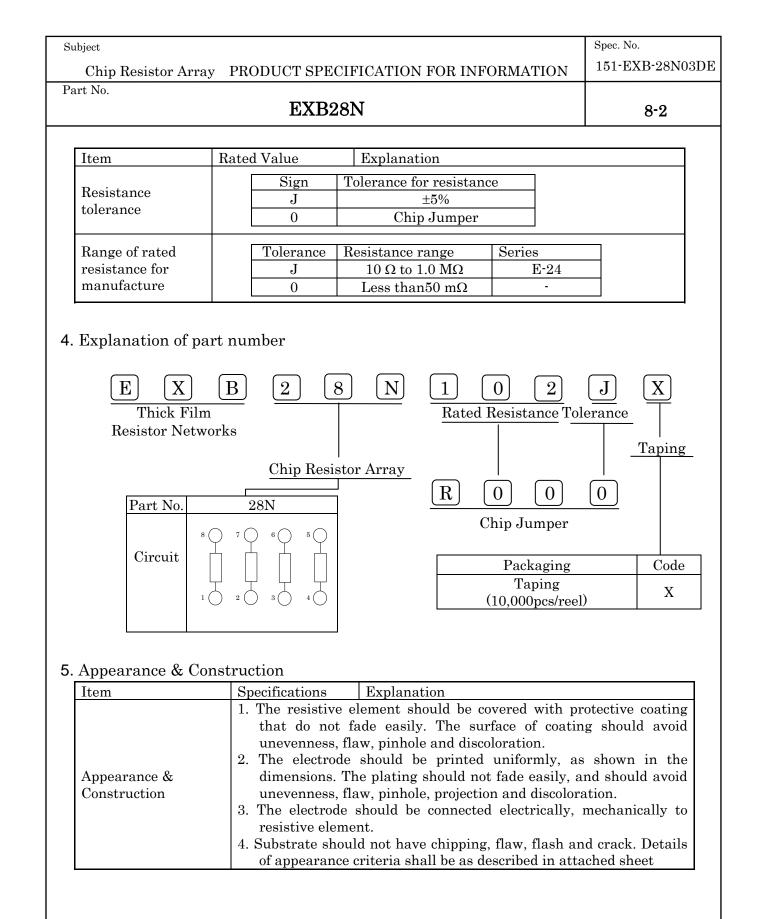
Subject Chip Resistor Array Part No. 1. Dimension A1 A2	PRODUCT SPECI	FICATION FOR I	NFORMATION	151-EXB-28N03D
Part No.		FIGATION FOR I	NFORMATION	
	EXB28			
1. Dimension $A1 A2$		N		8-1
$\Delta 1 \Delta 9$				
$\stackrel{A1}{\longleftrightarrow} \stackrel{A2}{\longleftrightarrow} _{a}$		(1)Substrate	(2)Protective coating	(3)Resistive element
		Alumina	Resin	Ruthenium oxide
	A	(4)Termination (Inner)	(5)Termination (Between)	(6) Termination (Outer)
		Ag or Ag/Pd Side∶Resin+Metal	Ni Plating	Sn Plating
$ \begin{array}{c c} P & \stackrel{ a'}{\leftarrow} \\ \leftarrow & L \\ \leftarrow & \end{array} $				
		tional plan (4) (5) (6)		
Dimension(mm)	L W 2.00±0.10 1.00±0	T 0.10 0.35±0.10	A1 0.45±0.10	A2 0.35±0.10
	B P	G	():R	Reference
Dimension(mm)	0.20 ± 0.10 (0.50		-	
2. Power derating curves 100 -55° C 100 -50 -100 -50 -100	70°C	-55°	gory temperature °C to +125°C	range
-60 -40 -20	0			
	Ambient Temperature(°	U)		
3. Ratings	Fig. 1			
Item	Rated Value	Explanation		
Rated Dissipation	0.063 W / element	When used at an the rated dissi shown in Fig.1		
	Chip jumper : Rated			
Rated voltage &	The rated voltage equation below, ar	nd when the rate	d voltage excee	ds the limiting
Rated Continuous Working Voltage (RCWV)	element voltage, the working voltage. $E = \sqrt{P \times R}$	Limiting elemen Limiting elemen V), P: Rated dissipa	nt voltage : 50 V	



As far as there shall be not designation especially, the following test and measurement shall be operated under normal temperature(15 °C to 35 °C), normal humidity(25 %RH to 75 %RH), normal atmospheric pressure(86 kPa to 106 kPa).

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6. Performance Specification	·
Specification The second secon	

Item	Specification	-	Test methods
Item	Resistor	Jumper	i est methous
DC resistance	DC resistance value shall be within the specified tolerance	Less than 50 mΩ	Measuring voltage: refer to JIS-C5201-1 At 20 °C, 65 %RH
Temperature coefficient	Resistance 10Ω to 1MΩ ±2 Chip jumper : Less than 5	TCR 00×10 ⁻⁶ / °C 0 mΩ	Natural resistance change per temperature degree centigrade. $TCR = \frac{R_2 \cdot R_1}{R_1 \times (t_2 \cdot t_1)}$ R1: Resistance value at reference temperature(t_1) R2: Resistance value at test temperature(t_2) t_2 \cdot t_1 = 100 °C, t_1 = 25 °C
Overload	±(2 %+0.1 Ω)	Less than 50 mΩ	Resistors shall be applied 2.5 times the rated voltage for 5 seconds. However, the upper limit of the voltage in the test shall be 100V. In addition, the current applied to the jumper in the test shall be 2A.
Dielectric Withstanding	No evidence of flashover, mechanical damage, arcing or insulation breakdown.		AC 100V between substrate and termination for 1 minute.
Insulation Resistance	Min. 1,000 MΩ		Insulation resistance between substrate and termination shall be measured at DC 100V.

7. Mechanical characteristic

Item	Specification		Test methods	
Item	Resistor	Jumper	rest methous	
Bend strength of	No mechanical dar	naec	Substrate: Glass epoxy(t = 1.0 mm) Span: 90 mm	
the face plating	±(1 %+0.05 Ω)	T 1	Bending distance: 3 mm (10 seconds)	
Solderability	Termination shou uniformly with sol (min. 95 % coverag	aer.	Resistors shall be dipped in the melted solder bath at 235 °C \pm 5 °C for 2 s \pm 0.5 s. Flux shall be removed from the surface of termination with clean organic solvent.	

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Itom	Specification		Test methods	
Item	Resistor	Jumper	Test methods	
Resistance to	$\pm (1 \% + 0.05 \Omega)$	Less than	Resistors shall be dipped in the melted solder	
soldering heat	±(1 %+0.03 22)	$50 \text{ m}\Omega$	bath at 270 °C \pm 5 °C for 10s \pm 1s.	
Vibration	±(1 %+0.05 Ω)	Less than 50 mΩ	Resistors shall be subjected to a single vibration having as double amplitude of 1.5 mm for 2 hours in each three mutually perpendicular directions for total 6 hours. The vibration frequency shall be varied uniformly 10 Hz to 55 Hz and return to 10 Hz traversing for 1 minute.	
	Without distinct of	deformation in	Solvent solution: Isopropyl alcohol	
	appearance		(1) Dipping 10 hours \pm 1 hour, dry in room	
Solvent resistance	±(0.5 %+0.05 Ω)	Less than 50 mΩ	 condition for 30 min ± 10 min. (2) Ultrasonic wave washing: 5 min ± 1 min (0.3 W/cm²,28 kHz) Dry in room condition for 30 min ± 10 min. 	

8. Environmental Test

Itom	Item Specification Test method		Test methods
Item	Resistor	Jumper	Test methods
Low temperature exposure	±(1 %+0.05 Ω)	Less than 50 mΩ	Resistors shall be exposed at -55 °C \pm 3 °C for 1000 hours $^{+48}_{-0}$ hours
Endurance at upper category temperature	±(1 %+0.05 Ω)	Less than 50 mΩ	Resistors shall be exposed at +125 °C±3 °C for 1000 hours $^{+48}_{0}$ hours.
Temperature cycling	±(1 %+0.05 Ω)	Less than 50 mΩ	-55 °C ± 3 °C, 30 minutes $\uparrow\downarrow$ Nominal temp., 30minutes 25cycles $\uparrow\downarrow$ +125 °C ± 3 °C, 30minutes
Humidity (Steady state)	±(1 %+0.05 Ω)	Less than 50 mΩ	Resistors shall be exposed at 60 °C \pm 2 °C and 90 % to 95 % relative humidity in a humidity test chamber for 1000 hours $_{0}^{+48}$ hours.
Endurance at 70 °C	±(3 %+0.1 Ω)	Less than 50 mΩ	Resistors shall be exposed at 70 °C \pm 2 °C for 1000 hours $_{0}^{+48}$ hours. During this time, the rated voltage shall be applied intermittently for 1.5 hours ON, 0.5 hour OFF.
Load life in Humidity	±(3 %+0.1 Ω)	Less than $50 \text{ m}\Omega$	Resistor shall be exposed at 60 °C \pm 2 °C and 90 % to 95 % relative humidity for 1000 hours $_{0}^{+48}$ hours. During this time, the rated voltage shall be applied intermittently for 1.5 hours ON, 0.5 hour OFF.

9. Resistance value marking

No marking.

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10. Notice for use	
I Notice for use	
 (1)This specification shows the quality and performance of the product in a unit adoption, be sure to evaluate and verify the product mounting it in your product (2)We take no responsibility for troubles caused by the product usage that is specification. 	uct.
 (3)In traffic transportation equipment (trains, cars, traffic signal equipment, equipment, aerospace equipment, electric heating appliances, combustion rotating equipment, disaster and crime preventive equipment, etc. in cases that the failure of this product gives serious damage to human life and others and ensure safety by studying the following items to Ensure safety as the system by setting protective circuits and protective 	and gas equipment, where it is forecast s, use fail-safe design
 Ensure safety as the system by setting such redundant circuits as do no single failure. (4)When a dogma shall be occurred about safety for this product, be sure to 	ot cause danger by a
 operate your technical examination. (5) The product is designed to use in general standard applications of general ele (AV products, household electric appliances, office equipment, information an equipment, etc.); hence, it do not take the use under the following special env consideration. Accordingly, the use in the following special environments, and such environ may affect the performance of the product; prior to use, verify the performance 	ectric equipment nd communication vironments into mental conditions
 thoroughly. 1) Use in liquids such as water, oil, chemical, and organic solvent. 2) Where the product is close to a heating component, or where an inflamma polyvinyl chloride wire is arranged close to the product. 3) Where the product is sealed or coated with resin, etc. 4) Where water or a water-soluble detergent is used in cleaning free solder attention to soluble flux.) 	
 5) Use in such a place where the product is wetted due to dew condensation. 6) Use in places full of corrosive gases such as sea breeze, Cl₂, H₂S, NH₃, SO 7) Use under direct sunlight, in outdoor or in dusty atmospheres. 8) Use in environment with large static electricity or strong electromagnetic (6)If transient load (heavy load on a short time) like pulse is expected to b evaluation and confirmation test with resistors actually mounted on your o load of more than rated power is applied under the load condition at steady performance and/or reliability of resistor. Never exceed the rated power. 	2, and NOx. 2 waves. e applied, carry out wn board. When the
 When the product shall be used under special condition, be sure to ask us in a (7)Halogen type (chlorine type, bromine type, etc.) or other high-activity flux is the residue may affect performance or reliability of resistors. (8)When soldering with soldering iron, never touch the body of the chip resists soldering iron. When using a soldering iron with a tip at high temperature, short as possible. (Three seconds or less up to 350 °C) (9)Avoid physical shock to the resistor and nipping of the resistor with hard too tweezers) as it may damage protective firm or the body of resistor and physical shore. 	not recommended as tor with a tip of the solder for a time as ol (a pair of pliers or
performance. (10)Reflow soldering method shall apply to this product in principle.	

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11. Storage method

If the product is stored in the following environments and conditions, the performance and solderability may be badly affected. Avoid the storage in the following environments.

- (1) Storage in places full of corrosive gases such as sea breeze, Cl₂, H₂S, NH₃, SO₂, and NO_X.
- (2) Storage in places exposed to direct sunlight.
- (3) Storage in places outside the temperature range of 5 °C to 35 °C and humidity range of 45 %RH to 85 %RH.
- (4) Storage over a year after our delivery (This item also applies to the case where the storage method specified in item (1) to (3) has been followed.).

12. Laws and Regulations

- (1) No ODCs or other ozone-depleting substances that are subject to regulation under the Montreal Protocol are used in our manufacturing processes, including in the manufacture of this product.
- (2) This product complies with the RoHS Directive (Restriction of the use of certain Hazardous Substances in electrical and electronic equipment (DIRECTIVE 2002/95/EC)).
- (3) All materials used in this product are existing chemical substances recognized under "lows on examination of chemical substances and regulations of manufacturing and others."
- (4) None of the materials used in this product contain the designated incombustible bromic substances, PBBOs and PBBs.
- (5) Please contact us to obtain a notice as to whether this product has passed inspection under review criteria primarily based on Foreign Exchange and Foreign Trade Control Laws, and appended table in the Export Control Laws.

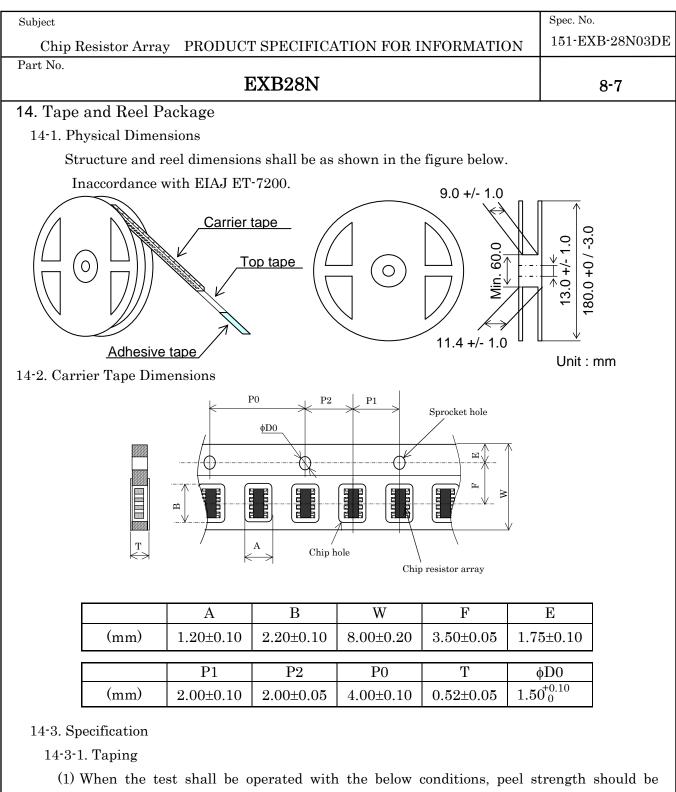
13. Production Place

Production Country : Japan

Production Plant : Panasonic Electronic Devices Japan Co., Ltd..

Production Country : China

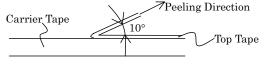
Production Plant : Panasonic Electronic Devices (Tianjin) Co., Ltd.(PEDTJ)



0.049N

to 0.49N, should not have flash and tear after peeling.

<Test Method>



(2) Minimum Bending Radius

When carrier tape shall be bent by minimum bending radius (15 mm), no defection of chip and no break of carrier tape. However minimum bending radius shall be tested for 1 times.

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(3) Resistance to climate		
When resistors shall be exposed at 60 °C \pm 2 °C, 90 %RH to 95 %RH for	120 hours, no	
defection of chip and no break off carrier tape.	,	
When the top tape shall be peeled, tape should not have flash and tear.		
14-3-2. Quantity in Taping: 10,000 pcs. / reel		
14-3-3. Tape packaging		
(1) Resistor side shall be facing upward.		
(2) Chip resistor shall not be sticking to top tape and bottom tape.		
(3) Chip resistors shall be easy to take out from carrier tape and chip hole	or sprocket hole	
shall not have flash and break.		
14-4. Outer Packaging		
Quantity: 20 reels(Max.200,000 pcs.)		
Таре		
Marking		
(1) When packaging quantity does not reach max quantity, the remaining	empty space shall	
be buried with buffer material.		

(2) When quantity shall be few, alternative packaging methods may used. No problem must occur during the exportation of the product..

14-5. Marking

At last, production country is displayed in English.

- Side of reel (Marking shall be on one side.)
 - (1)Part name(2)Part number(3)Quantity(4)Lot number(5)Maker name(6)Production country
- •Packaging box

(1)Customer name(2)Part name(3)Part number(4)Customer part number(5)Quantity(6)Maker name(7) Production country

